



BAP50-03

Silicon PIN diode

Rev. 5.1 — 8 February 2019

Product data sheet

1 Product profile

1.1 General description

General-purpose PIN diode in an SOD323 small plastic SMD package.

1.2 Features and benefits

- Low diode capacitance
- Low diode forward resistance



1.3 Applications

- General RF application



2 Pinning information

Table 1. Discrete pinning

Pin	Description	Simplified outline	Graphic symbol
1	cathode		 <i>sym006</i>
2	anode		

Top view

3 Ordering information

Table 2. Ordering information

Type number	Package		
	Name	Description	Version
BAP50-03	SC-76	plastic surface-mounted package; 2 leads	SOD323

4 Marking

Table 3. Marking code

Type number	Marking code
BAP50-03	A8 ^[1]

[1] The marking bar indicates the cathode (see [Table 1](#)).

5 Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_R	reverse voltage		-	50	V
I_F	forward current		-	50	mA
P_{tot}	total power dissipation	$T_{sp} \leq 90\text{ °C}$	-	500	mW
T_{stg}	storage temperature		-65	+150	°C
T_j	junction temperature		-65	+150	°C

6 Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Typ	Unit
$R_{th(j-sp)}$	thermal resistance from junction to solder point		85	K/W

7 Characteristics

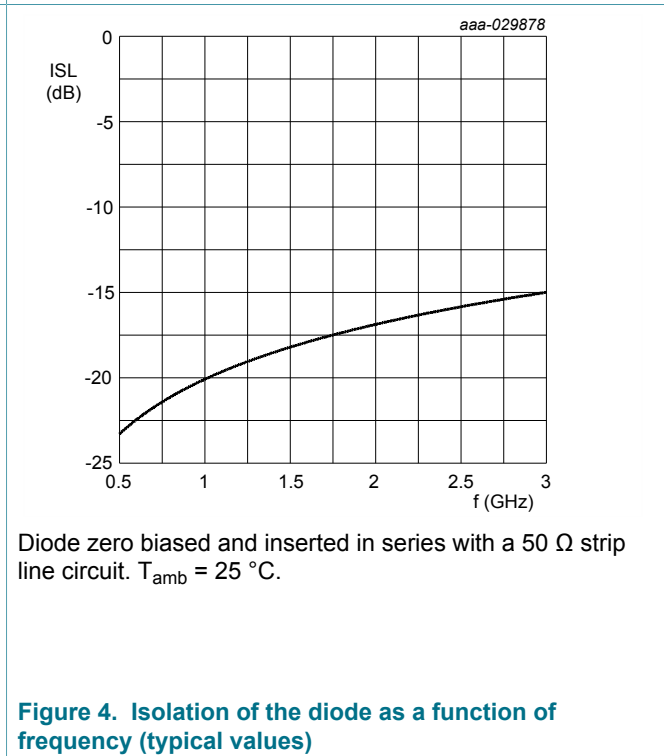
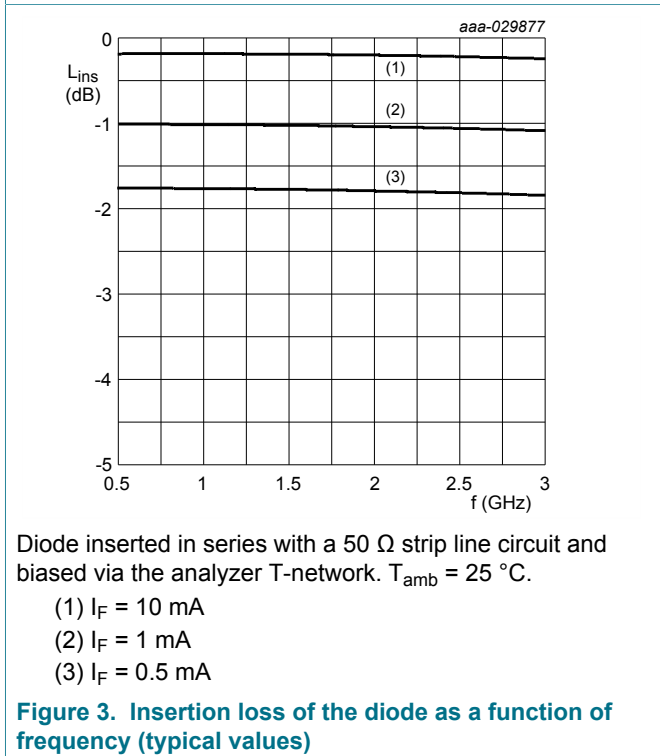
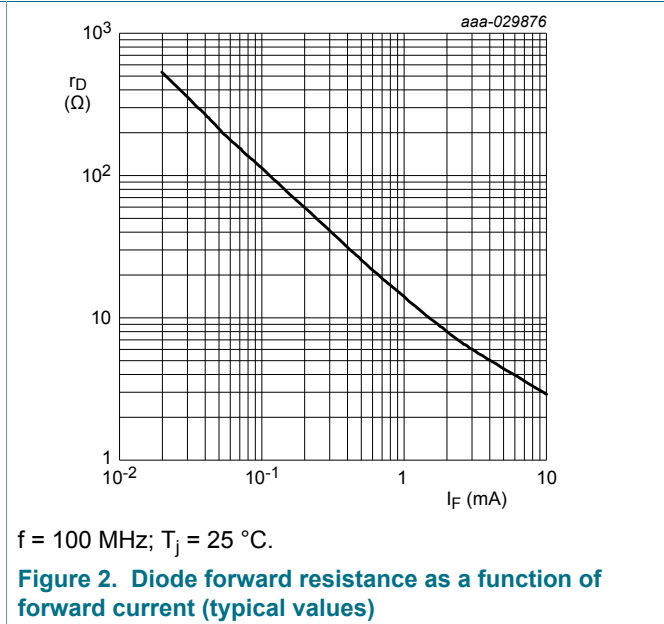
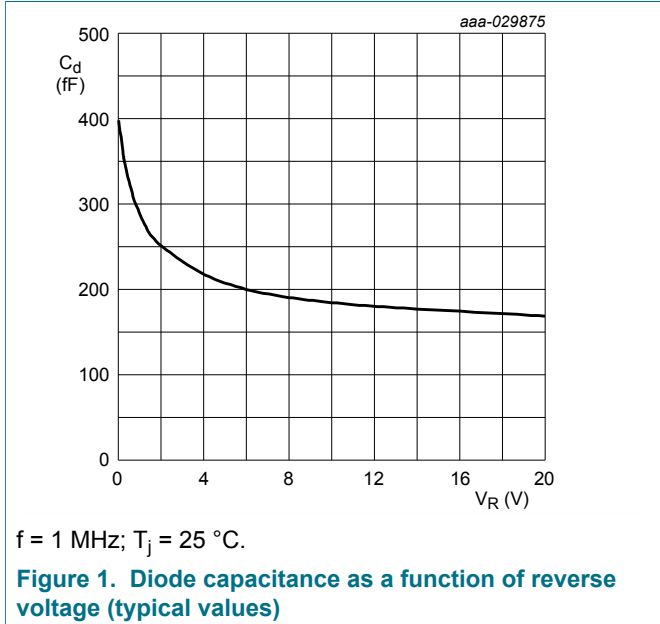
Table 6. Characteristics

$T_j = 25\text{ °C}$ unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit	
V_F	forward voltage	$I_F = 50\text{ mA}$	-	0.95	1.1	V	
V_R	reverse voltage	$I_R = 10\text{ }\mu\text{A}$	50	-	-	V	
I_R	reverse current	$V_R = 50\text{ V}$	-	-	100	nA	
C_d	diode capacitance	f = 1 MHz (see Figure 1)					
		$V_R = 0\text{ V}$	-	0.4	-	pF	
		$V_R = 1\text{ V}$	-	0.3	0.55	pF	
		$V_R = 5\text{ V}$	-	0.2	0.35	pF	
r_D	diode forward resistance	f = 100 MHz (see Figure 2)					
		$I_F = 0.5\text{ mA}$	[1]	-	25	40	Ω
		$I_F = 1\text{ mA}$	[1]	-	14	25	Ω
		$I_F = 10\text{ mA}$	[1]	-	3	5	Ω

[1] Guaranteed on AQL basis: inspection level S4, AQL 1.0.

8 Graphical data



9 Package outline

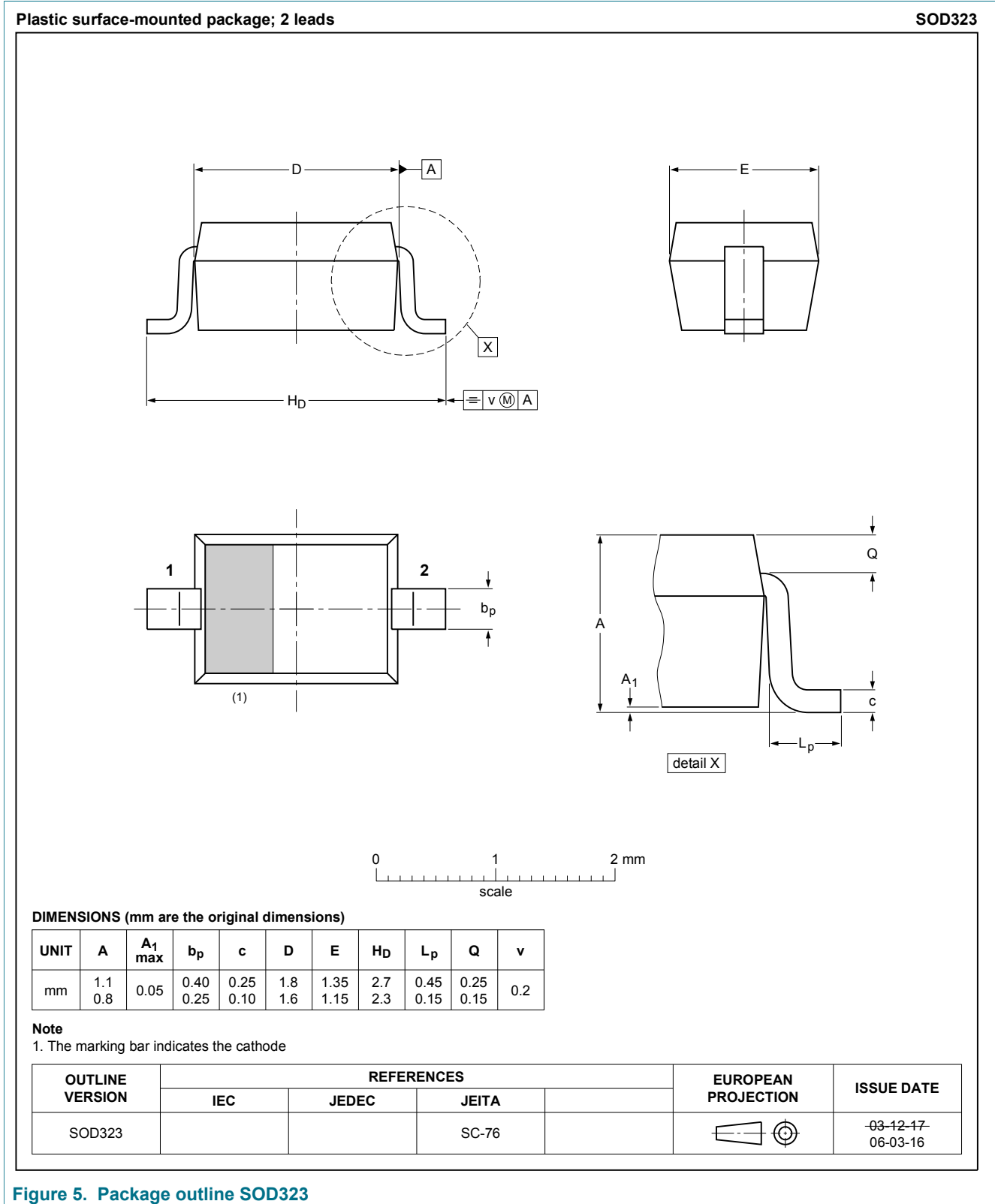


Figure 5. Package outline SOD323

10 Abbreviations

Table 7. Abbreviations

Acronym	Description
AQL	acceptable quality level
PIN	P-type, intrinsic, N-type
RF	radio frequency
S4	special inspection level 4
SMD	surface-mounted device

11 Revision history

Table 8. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BAP50-03 v.5.1	20190208	Product data sheet	-	BAP50-03 v.5
Modifications:	<ul style="list-style-type: none"> aligned the title of the data sheet with the description on the Internet 			
BAP50-03 v.5	20182611	Product data sheet	-	BAP50-03 v.4
Modifications:	<ul style="list-style-type: none"> Section 1.2 "Features and benefits" has been updated. The "Legal information" pages have been updated. 			
BAP50-03 v.4	20090911	Product data sheet	-	BAP50-03 v.3
BAP50-03 v.3	20040211	Product data sheet	-	BAP50-03 v.2
BAP50-03 v.2	19990510	Product data sheet	-	BAP50-03 v.1
BAP50-03 v.1	19990201	Preliminary data sheet	-	-